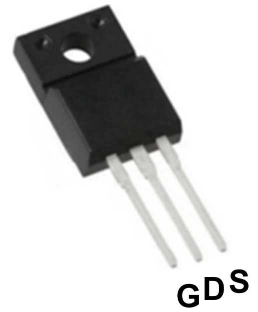
WAYON

WML340N20HG2

200V N-Channel Enhancement Mode Power MOSFET



TO-220F

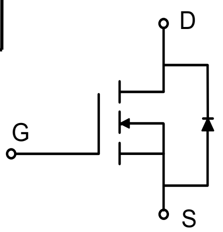
Description

WML340N20HG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.

Features

- V_{DS} = 200V, I_D = 28A
  $R_{DS(on)}$ < 34mΩ @ V_{GS} = 10V
- High Speed Power Switching
- 100% EAS Guaranteed
- Low Gate Charge

RoHS compliant



Applications

- DC/DC Converter
- LED Backlighting
- Motor Control

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	200	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current[1]	T_C=25°C	I_D	28	A
	T_C=100°C		18	
Pulsed Drain Current[2]		I_{DM}	112	A
Single Pulse Avalanche Energy[3]		EAS	105.8	mJ
Total Power Dissipation[4]	T_C=25°C	P_D	59.5	W
Operating Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient[1]	$R_{\theta JA}$	60	°C/W
Thermal Resistance from Junction-to-Case[1]	$R_{\theta JC}$	2.1	°C/W

Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics							
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	200	-	-	V
Gate-Body Leakage Current		I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	T_J=25°C	I_{DSS}	V_{DS} = 200V, V_{GS} = 0V	-	-	1	μA
	T_J=100°C			-	-	100	
Gate-Threshold Voltage		$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	2	3	4	V
Drain-Source on-Resistance[2]		$R_{DS(on)}$	V_{GS} = 10V, I_D = 8A	-	27	34	mΩ
Forward Transconductance[2]		g_{fs}	V_{DS} = 5V, I_D = 10A	-	32	-	S
Dynamic Characteristics							
Input Capacitance		C_{iss}	V_{DS} = 100V, V_{GS} =0V, f =1MHz	-	1712	-	pF
Output Capacitance		C_{oss}		-	141	-	
Reverse Transfer Capacitance		C_{rss}		-	8	-	
Switching Characteristics							
Gate Resistance		R_G	V_{DS} = 0V, V_{GS} =0V, f =1MHz	-	3.4	-	Ω
Total Gate Charge		Q_g	V_{GS} = 10V, V_{DS} = 100V, I_D= 10A	-	23	-	nC
Gate-Source Charge		Q_{gs}		-	8.2	-	
Gate-Drain Charge		Q_{gd}		-	2.4	-	
Turn-on Delay Time		$t_{d(on)}$	V_{GS} =10V, V_{DS} = 100V, R_G = 10Ω, I_D= 10A	-	14.5	-	ns
Rise Time		t_r		-	20	-	
Turn-off Delay Time		$t_{d(off)}$		-	26	-	
Fall Time		t_f		-	12.5	-	
Drain-Source Body Diode Characteristics							
Diode Forward Voltage[2]		V_{SD}	I_S = 1A, V_{GS} = 0V	-	-	1.2	V
Continuous Source Current[1,5]		I_S	V_G=V_D=0V , Force Current	-	-	28	A
Body Diode Reverse Recovery Time		t_{rr}	V_R = 100V ,I_F = 10A, dI/dt = 100A/μs	-	85	-	ns
Body Diode Reverse Recovery Charge		Q_{rr}		-	300	-	nC

Notes:

1.The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%

3.The EAS data shows Max. rating . The test condition is V_{DD}=25V, V_{GS}=10V, L=0.4mH, I_{AS}=23A

4.The power dissipation is limited by 175°C junction temperature

5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

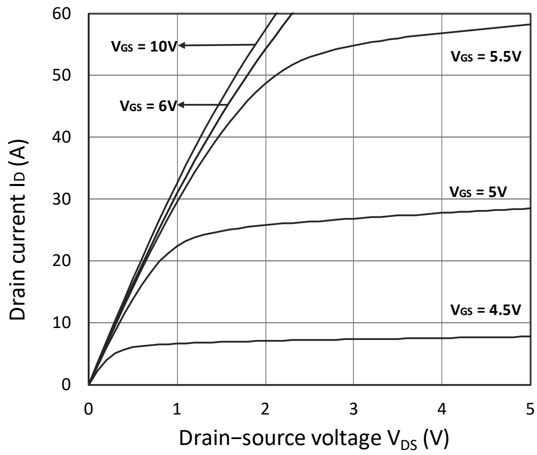


Figure 1. Output Characteristics

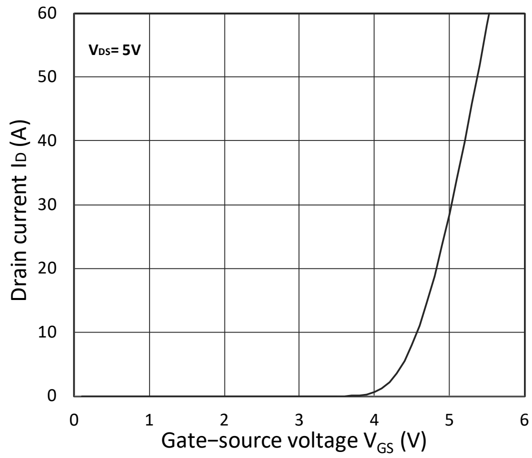


Figure 2. Transfer Characteristics

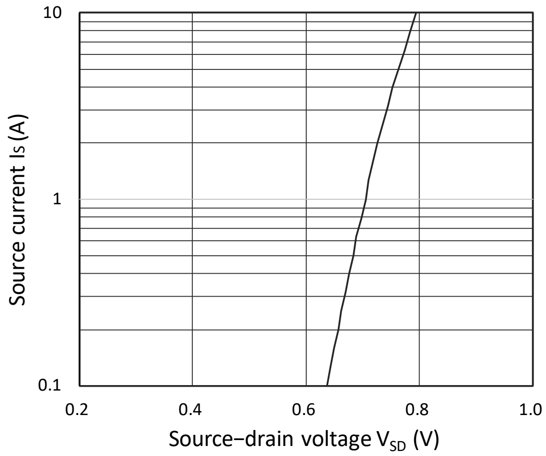


Figure 3. Forward Characteristics of Reverse

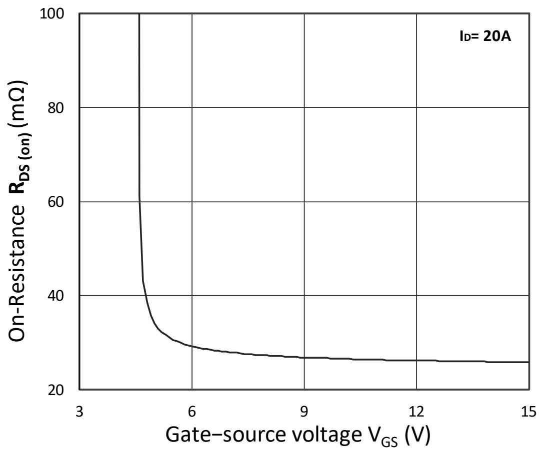


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

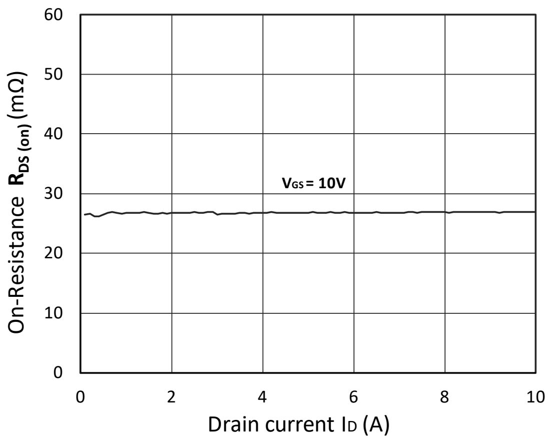


Figure 5. $R_{DS(ON)}$ vs. I_D

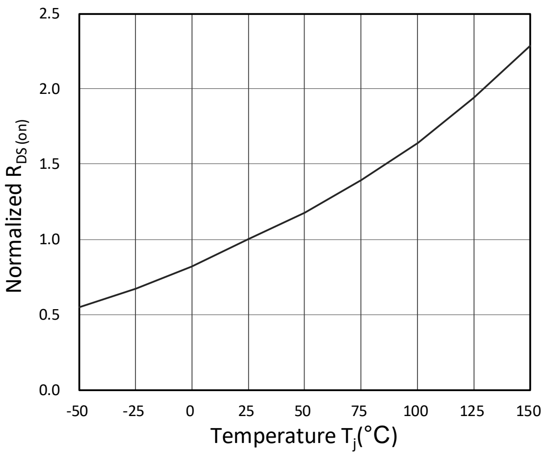


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

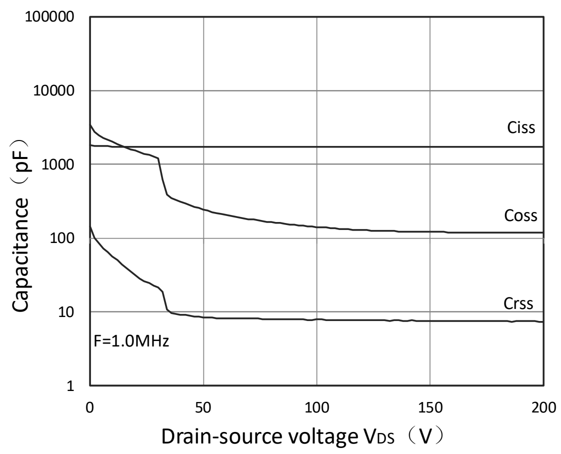


Figure 7. Capacitance Characteristics

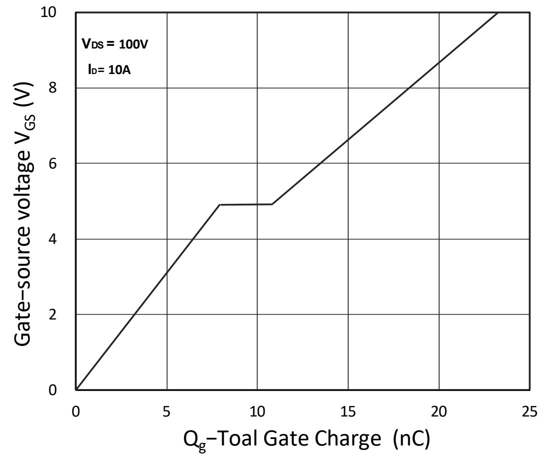


Figure 8. Gate Charge Characteristics

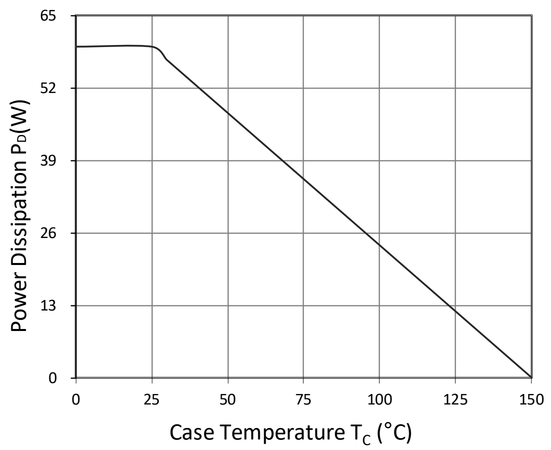


Figure 9. Power Dissipation

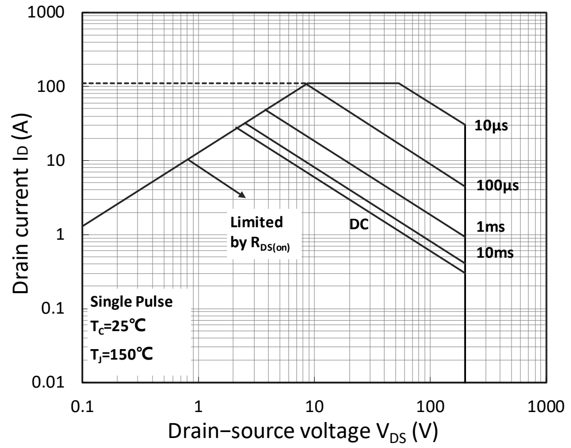


Figure10. Safe Operating Area

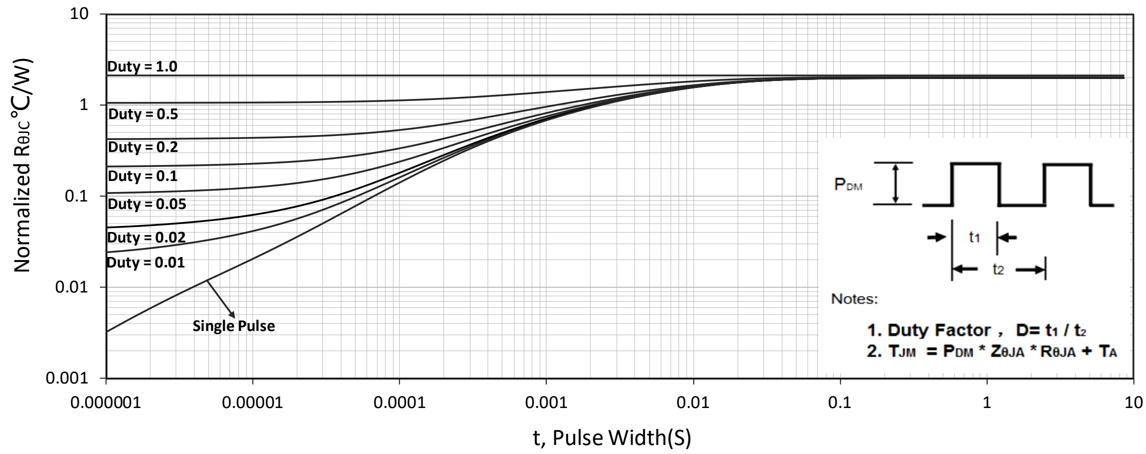


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

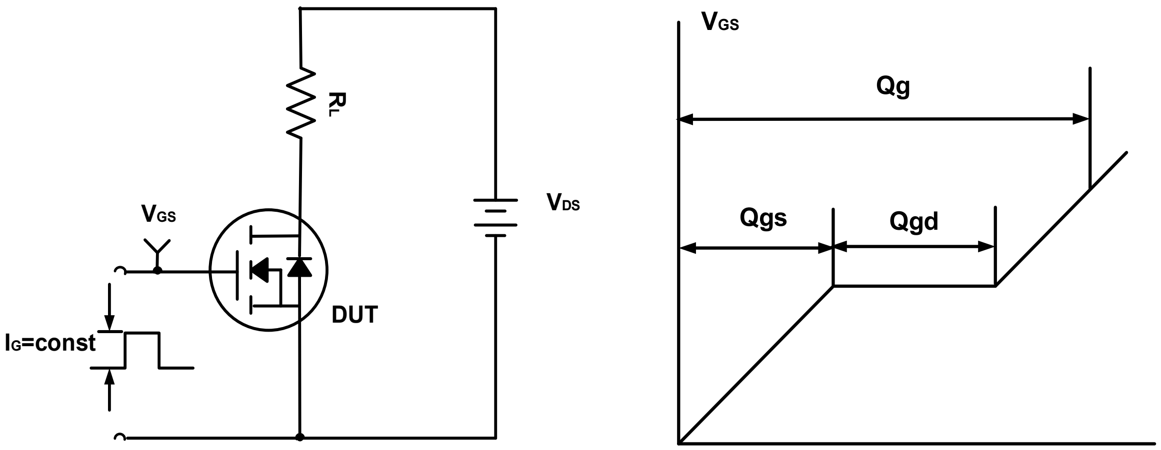


Figure A. Gate Charge Test Circuit & Waveforms

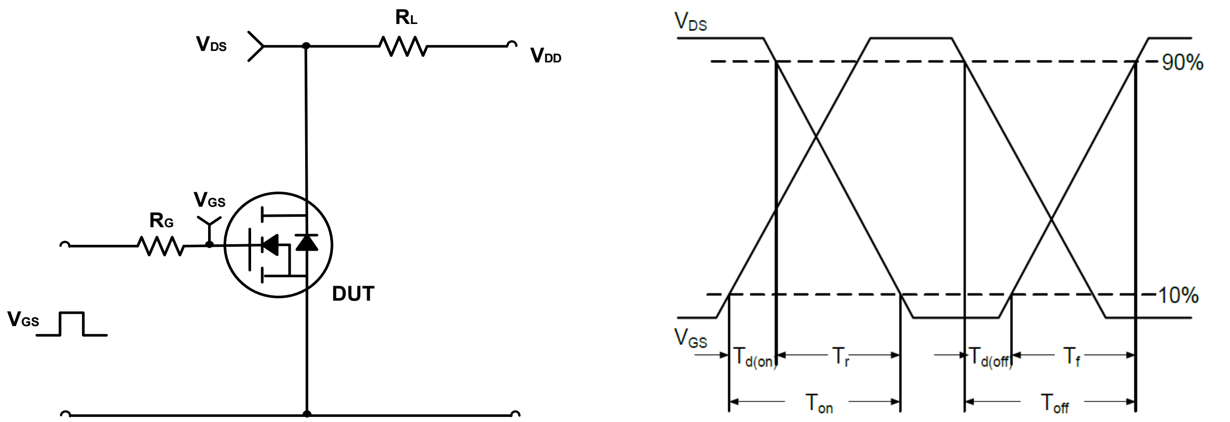
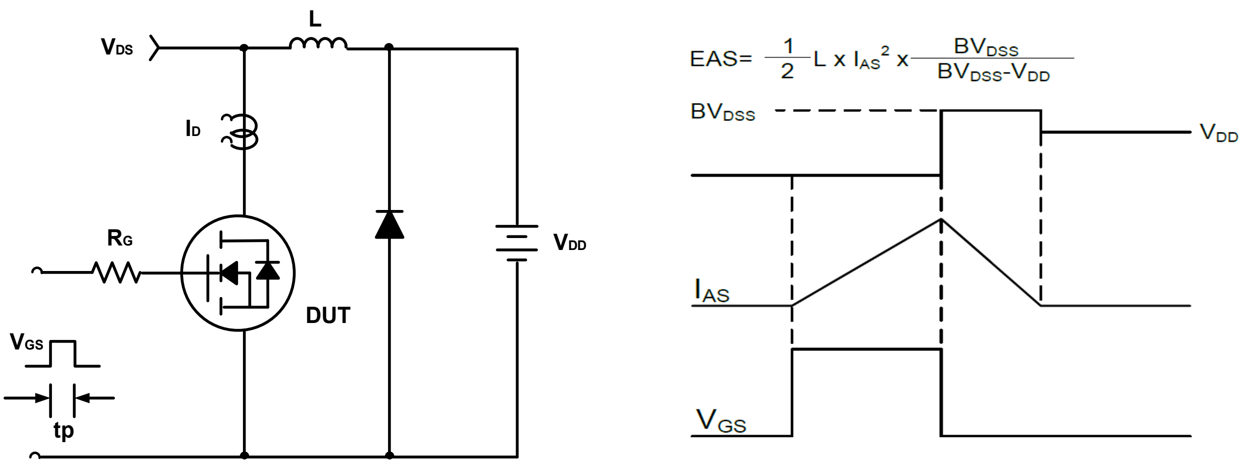


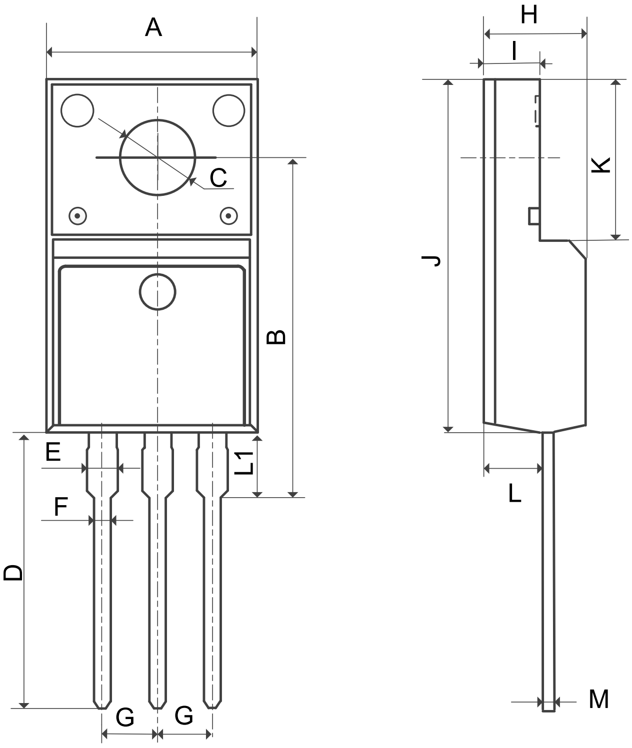
Figure B. Switching Test Circuit & Waveforms



$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

Figure C. Unclamped Inductive Switching Circuit & Waveforms

Mechanical Dimensions for TO-220F



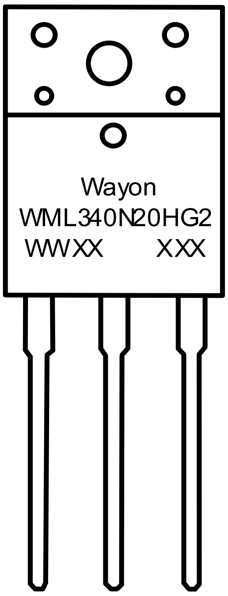
COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	9.96	10.36
B	15.10	16.10
C	3.03	3.38
D	12.64	13.38
E	1.18	1.58
F	0.65	0.95
G	2.54REF	
H	4.50	4.90
I	2.34	2.74
J	15.57	16.17
K	6.70REF	
L	2.56	2.96
M	0.40	0.60
L1	2.85	3.50

Ordering Information

Part	Package	Marking	Packing method
WML340N20HG2	TO-220F	WML340N20HG2	Tube

Marking Information



WML340N20HG2 = Device code

WWXX XXX= Date code

Contact Information

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